

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
XIAO YAN LI	12/21/2021
YI BO HU	12/21/2021
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<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16493542
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<b>ATTORNEY DOCKET NUMBER:</b>	04435/005633-US1
<b>NAME OF SUBMITTER:</b>	ALMA D. CLEMENA FOR MCG
<b>SIGNATURE:</b>	/Alma D. Clemena/
<b>DATE SIGNED:</b>	12/24/2021
<b>Total Attachments: 2</b>	
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source=20211222 IN executed Assignment (Inv to HKU)#page2.tif	

## ASSIGNMENT

WHEREAS, I, **Xiao Yan LI**, a citizen of Hong Kong, China, residing at Flat G, 18<sup>th</sup> Floor, Block 26, South Horizons, Hong Kong;

WHEREAS, I, **Yi Bo HU**, a citizen China, residing at Room 1305, Number 61, Kai Yue Xin Cheng, Jinhu Road, Xiamen, Fujian, China;

(Hereinafter "ASSIGNOR") are the inventors of the invention in

### **SYNTHESIS OF A THIN INSOLUBLE HYDROXIDE SHELL ON THE SURFACE OF MAGNETIC ZERO-VALENT METAL NANOPARTICLES FOR ENVIRONMENTAL REMEDIATION**

for which we have executed an application for a Patent of the United States

which is identified by Leason Ellis LLP docket no. 04435/005633-US1  
which was filed on Sept 12, 2019, Application No. 16/493,542

and WHEREAS, The University of Hong Kong, ASSIGNEE, located at Pokfulam Road, HONG KONG is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

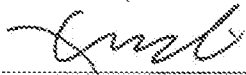
NOW, THEREFORE, in consideration of the sum of One Dollar (US\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, WE, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest (including without limitation all rights to sue for past, present and future infringement, to collect royalties and all causes of action and enforcement rights, whether known or unknown, currently pending or otherwise, including the right to pursue damages, injunctive relief and other infringement remedies) in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewal and reissues thereof;


AND WE HEREBY authorize and request the Commissioner of Patents, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

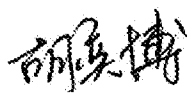
AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

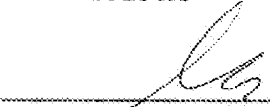
AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testifying in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, we hereunto set our hands and seals the day and year set opposite our respective signatures.

Date Dec 21, 2021  L.S.  
Xiao Yan Li

Witness:  
Lok Ya Ho   
Printed Name Signature of Witness

Date Dec 21, 2021  L.S.  
Yi Bo HU

Witness:  
Paul Cheung   
Printed Name Signature of Witness